

### General Description

The Alpha IGBT™ line of products offers best-in-class performance in conduction and switching losses, with robust short circuit capability. They are designed for ease of paralleling, minimal gate spike under high dV/dt conditions and resistance to oscillations. The soft co-packaged diode is targeted for minimal losses in Welding machines, Solar Inverter and UPS applications.

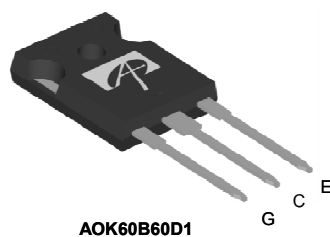
### Product Summary

$V_{CE}$	600V
$I_C$ ( $T_C=100^\circ\text{C}$ )	60A
$V_{CE(sat)}$ ( $T_C=25^\circ\text{C}$ )	1.85V

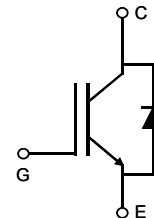


Top View

TO-247



AOK60B60D1



### Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOK60B60D1	Units	
Collector-Emitter Voltage	$V_{CE}$	600	V	
Gate-Emitter Voltage	$V_{GE}$	$\pm 20$	V	
$V_{GE}$ Spike	500ns	$V_{SPIKE}$	24	V
Continuous Collector Current	$I_C$	$T_C=25^\circ\text{C}$	120	A
		$T_C=100^\circ\text{C}$	60	
Pulsed Collector Current, Limited by $T_{Jmax}$	$I_{CM}$	210	A	
Turn off SOA, $V_{CE} \leq 600\text{V}$ , Limited by $T_{Jmax}$	$I_{LM}$	210	A	
Continuous Diode Forward Current	$I_F$	$T_C=25^\circ\text{C}$	60	A
		$T_C=100^\circ\text{C}$	30	
Diode Pulsed Current, Limited by $T_{Jmax}$	$I_{FM}$	210	A	
Short circuit withstanding time $V_{GE} = 15\text{V}$ , $V_{CE} \leq 400\text{V}$ , Delay between short circuits $\geq 1.0\text{s}$ , $T_C=25^\circ\text{C}$	$t_{SC}$	10	$\mu\text{s}$	
Power Dissipation	$P_D$	$T_C=25^\circ\text{C}$	417	W
		$T_C=100^\circ\text{C}$	167	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	$^\circ\text{C}$	
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	$T_L$	300	$^\circ\text{C}$	

### Thermal Characteristics

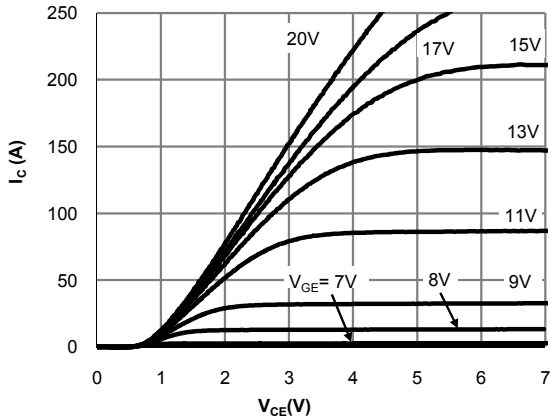
Parameter	Symbol	AOK60B60D1	Units
Maximum Junction-to-Ambient	$R_{\theta JA}$	40	$^\circ\text{C/W}$
Maximum IGBT Junction-to-Case	$R_{\theta JC}$	0.3	$^\circ\text{C/W}$
Maximum Diode Junction-to-Case	$R_{\theta JC}$	0.95	$^\circ\text{C/W}$

**Electrical Characteristics (T<sub>J</sub>=25°C unless otherwise noted)**

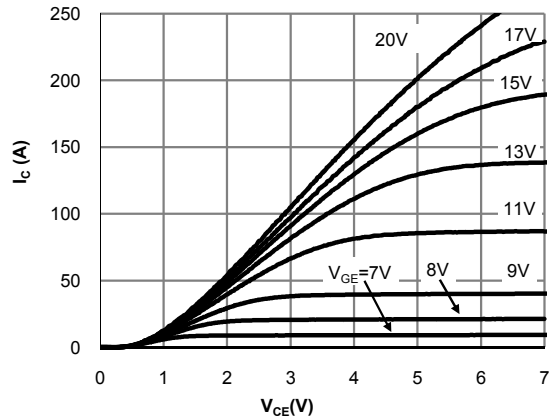
Symbol	Parameter	Conditions	Min	Typ	Max	Units	
<b>STATIC PARAMETERS</b>							
$BV_{CES}$	Collector-Emitter Breakdown Voltage	$I_C=1mA, V_{GE}=0V, T_J=25^\circ C$	600	-	-	V	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, I_C=60A$	$T_J=25^\circ C$	-	1.85	2.4	V
			$T_J=125^\circ C$	-	2.2	-	
			$T_J=150^\circ C$	-	2.3	-	
$V_F$	Diode Forward Voltage	$V_{GE}=0V, I_C=30A$	$T_J=25^\circ C$	-	1.34	1.9	V
			$T_J=125^\circ C$	-	1.31	-	
			$T_J=150^\circ C$	-	1.28	-	
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$V_{CE}=5V, I_C=1mA$	-	5.4	-	V	
$I_{CES}$	Zero Gate Voltage Collector Current	$V_{CE}=600V, V_{GE}=0V$	$T_J=25^\circ C$	-	-	10	$\mu A$
			$T_J=125^\circ C$	-	-	1000	
			$T_J=150^\circ C$	-	-	5000	
$I_{GES}$	Gate-Emitter leakage current	$V_{CE}=0V, V_{GE}=\pm 20V$	-	-	$\pm 100$	nA	
$g_{FS}$	Forward Transconductance	$V_{CE}=20V, I_C=60A$	-	25	-	S	
<b>DYNAMIC PARAMETERS</b>							
$C_{ies}$	Input Capacitance	$V_{GE}=0V, V_{CE}=25V, f=1MHz$	-	3288	-	pF	
$C_{oes}$	Output Capacitance		-	369	-	pF	
$C_{res}$	Reverse Transfer Capacitance		-	11.3	-	pF	
$Q_g$	Total Gate Charge	$V_{GE}=15V, V_{CE}=480V, I_C=60A$	-	75	-	nC	
$Q_{ge}$	Gate to Emitter Charge		-	27.3	-	nC	
$Q_{gc}$	Gate to Collector Charge		-	24.7	-	nC	
$I_{C(SC)}$	Short circuit collector current, Max. 1000 short circuits, Delay between short circuits $\geq 1.0s$	$V_{GE}=15V, V_{CE}=400V, R_G=25\Omega$	-	210	-	A	
$R_g$	Gate resistance	$f=1MHz$	-	1.4	-	$\Omega$	
<b>SWITCHING PARAMETERS, (Load Inductive, T<sub>J</sub>=25°C)</b>							
$t_{D(on)}$	Turn-On DelayTime	$T_J=25^\circ C$ $V_{GE}=15V, V_{CE}=400V, I_C=60A,$ $R_G=5\Omega,$ Parasitic Inductance=150nH	-	32	-	ns	
$t_r$	Turn-On Rise Time		-	76	-	ns	
$t_{D(off)}$	Turn-Off Delay Time		-	74	-	ns	
$t_f$	Turn-Off Fall Time		-	16	-	ns	
$E_{on}$	Turn-On Energy		-	3.1	-	mJ	
$E_{off}$	Turn-Off Energy		-	0.73	-	mJ	
$E_{total}$	Total Switching Energy		-	3.8	-	mJ	
$t_{rr}$	Diode Reverse Recovery Time		$T_J=25^\circ C$	-	137	-	ns
$Q_{rr}$	Diode Reverse Recovery Charge		$I_F=30A, dl/dt=200A/\mu s, V_{CE}=400V$	-	0.84	-	$\mu C$
$I_{rm}$	Diode Peak Reverse Recovery Current			-	10	-	A
<b>SWITCHING PARAMETERS, (Load Inductive, T<sub>J</sub>=150°C)</b>							
$t_{D(on)}$	Turn-On DelayTime	$T_J=150^\circ C$ $V_{GE}=15V, V_{CE}=400V, I_C=60A,$ $R_G=5\Omega,$ Parasitic Inductance=150nH	-	31	-	ns	
$t_r$	Turn-On Rise Time		-	78	-	ns	
$t_{D(off)}$	Turn-Off Delay Time		-	89	-	ns	
$t_f$	Turn-Off Fall Time		-	16	-	ns	
$E_{on}$	Turn-On Energy		-	3.5	-	mJ	
$E_{off}$	Turn-Off Energy		-	1.2	-	mJ	
$E_{total}$	Total Switching Energy		-	4.7	-	mJ	
$t_{rr}$	Diode Reverse Recovery Time		$T_J=150^\circ C$	-	234	-	ns
$Q_{rr}$	Diode Reverse Recovery Charge		$I_F=30A, dl/dt=200A/\mu s, V_{CE}=400V$	-	1.7	-	$\mu C$
$I_{rm}$	Diode Peak Reverse Recovery Current			-	13.8	-	A

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

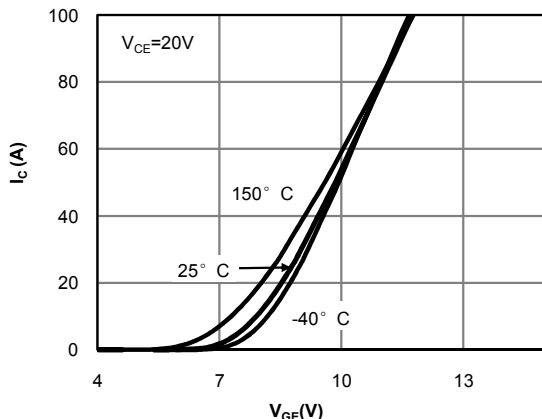
**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



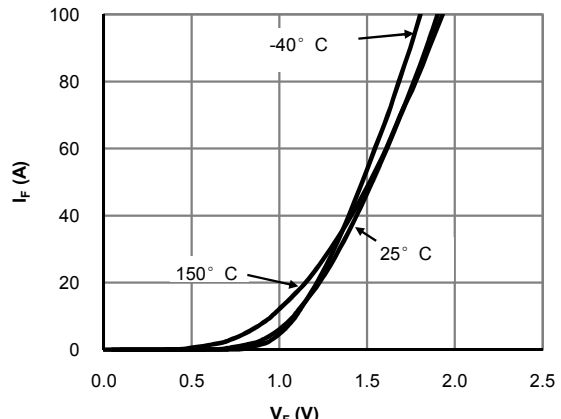
**Fig 1: Output Characteristic**  
( $T_j=25^\circ\text{C}$ )



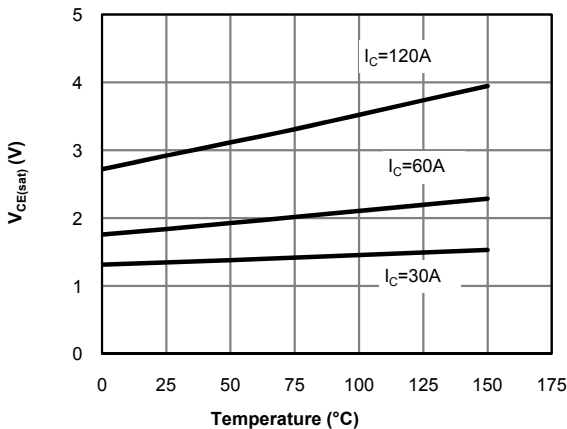
**Fig 2: Output Characteristic**  
( $T_j=150^\circ\text{C}$ )



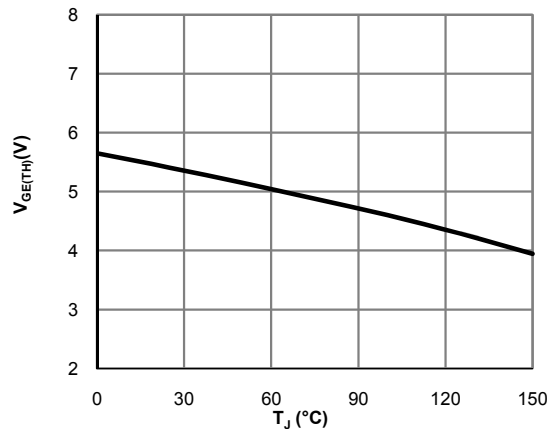
**Fig 3: Transfer Characteristic**



**Fig 4: Diode Characteristic**

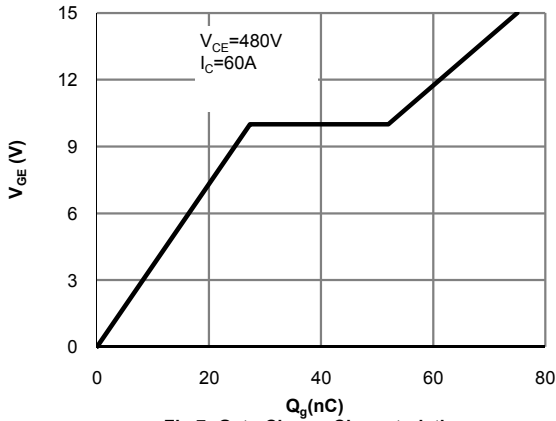


**Fig 5: Collector-Emitter Saturation Voltage vs. Junction Temperature**

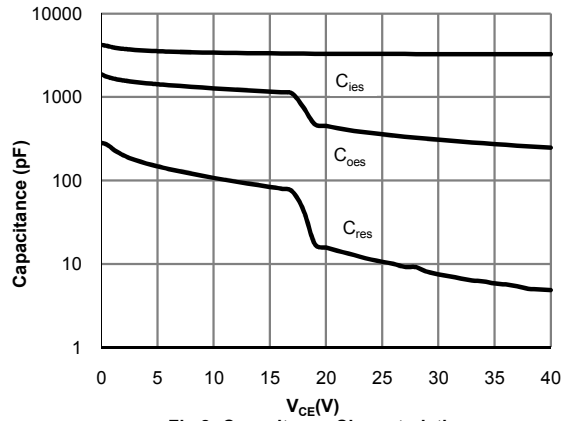


**Figure 6:  $V_{GE(TH)}$  vs.  $T_j$**

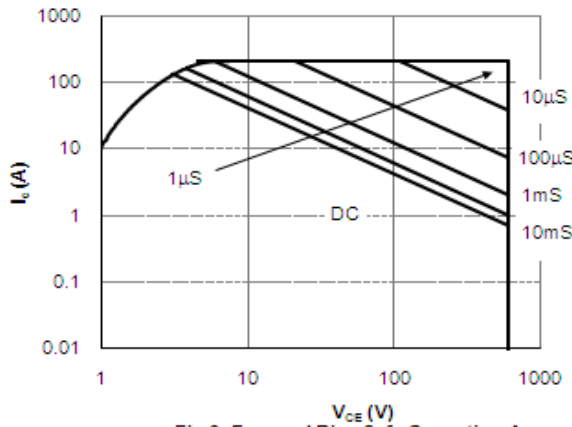
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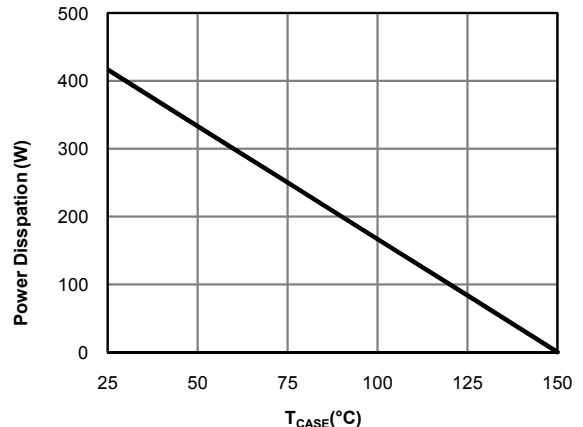
**Fig 7: Gate-Charge Characteristics**



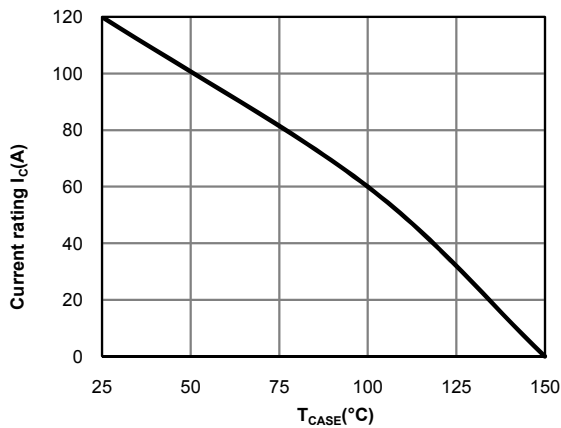
**Fig 8: Capacitance Characteristic**



**Fig 9: Forward Bias Safe Operating Area**  
( $T_C=25^\circ\text{C}, V_{GE}=15\text{V}$ )

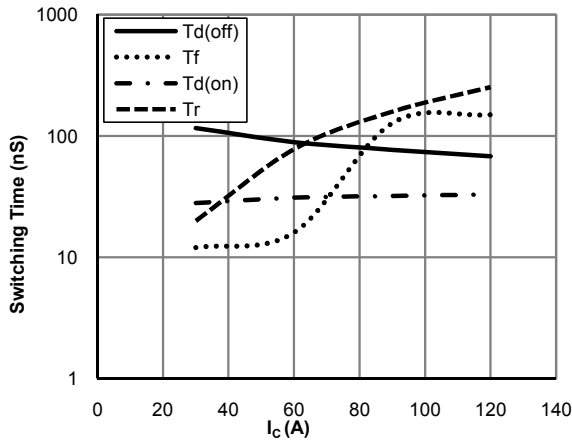


**Fig 10: Power Dissipation as a Function of Case**

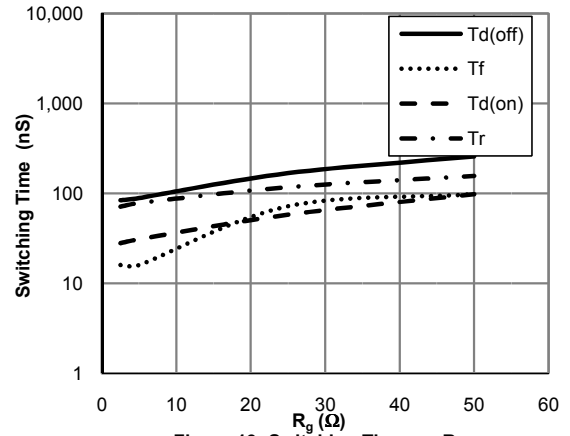


**Fig 11: Current De-rating**

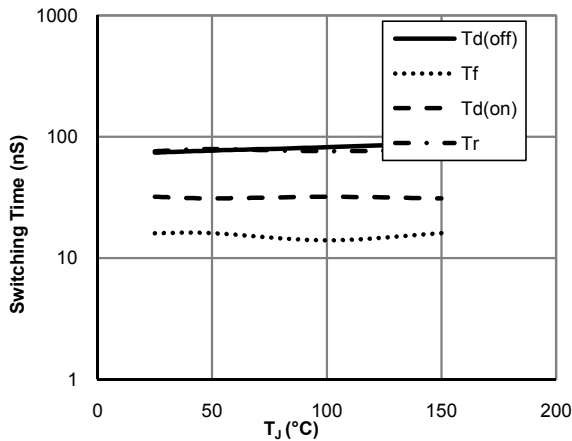
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**Figure 12: Switching Time vs.  $I_C$**   
( $T_J=150^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, R_g=5\Omega$ )

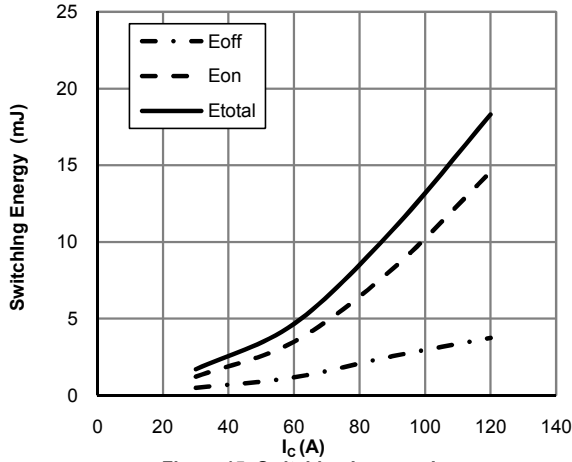


**Figure 13: Switching Time vs.  $R_g$**   
( $T_J=150^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=60\text{A}$ )

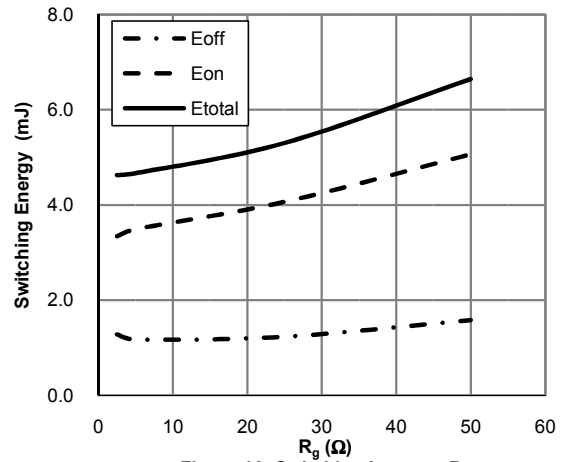


**Figure 14: Switching Time vs.  $T_J$**   
( $V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=60\text{A}, R_g=5\Omega$ )

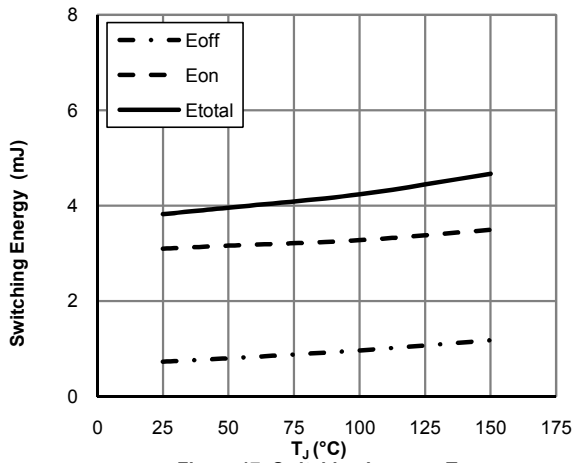
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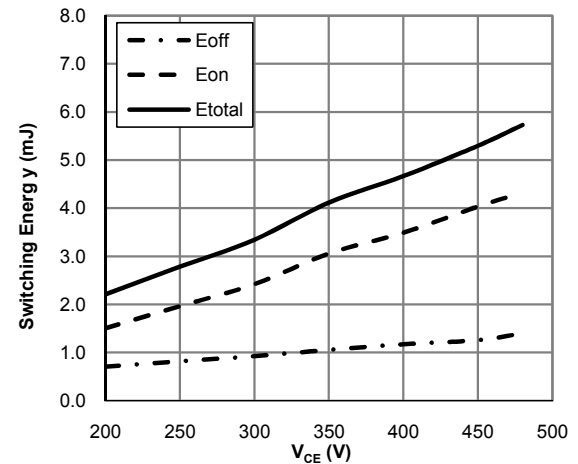
**Figure 15: Switching Loss vs.  $I_C$**   
( $T_J=150^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, R_g=5\Omega$ )



**Figure 16: Switching Loss vs.  $R_g$**   
( $T_J=150^\circ\text{C}, V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=60\text{A}$ )

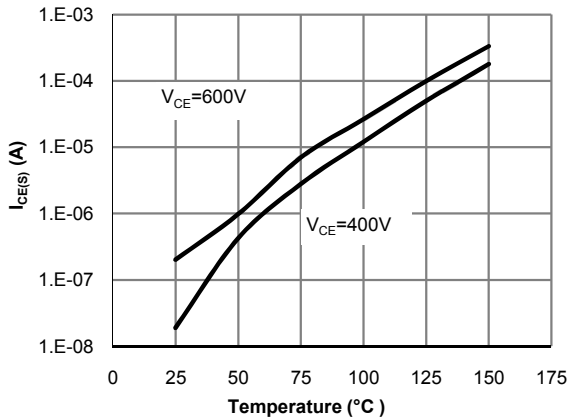


**Figure 17: Switching Loss vs.  $T_J$**   
( $V_{GE}=15\text{V}, V_{CE}=400\text{V}, I_C=60\text{A}, R_g=5\Omega$ )

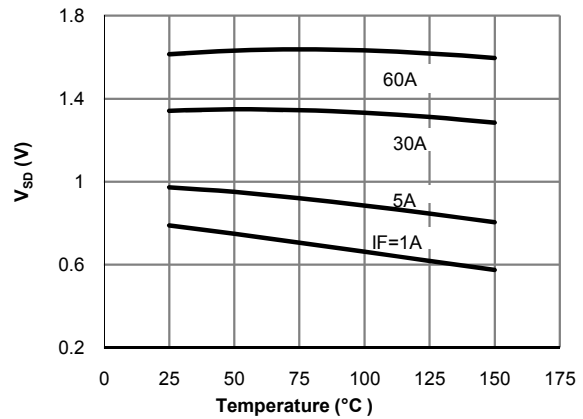


**Figure 18: Switching Loss vs.  $V_{CE}$**   
( $T_J=150^\circ\text{C}, V_{GE}=15\text{V}, I_C=60\text{A}, R_g=5\Omega$ )

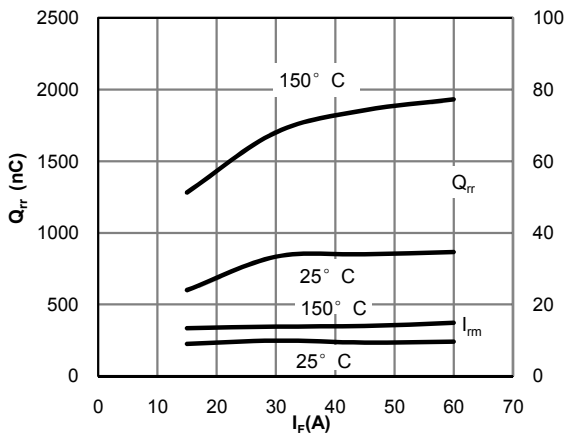
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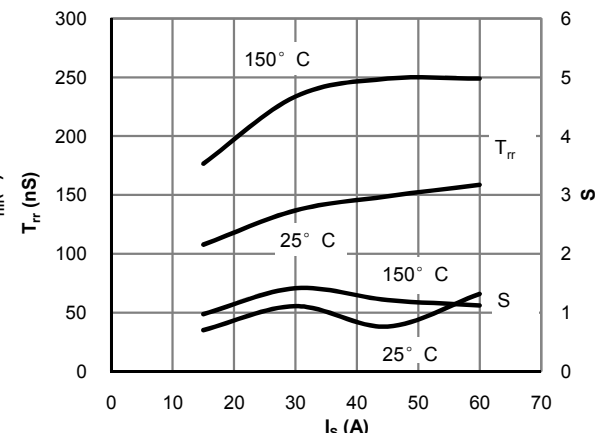
**Fig 19: Diode Reverse Leakage Current vs. Junction Temperature**



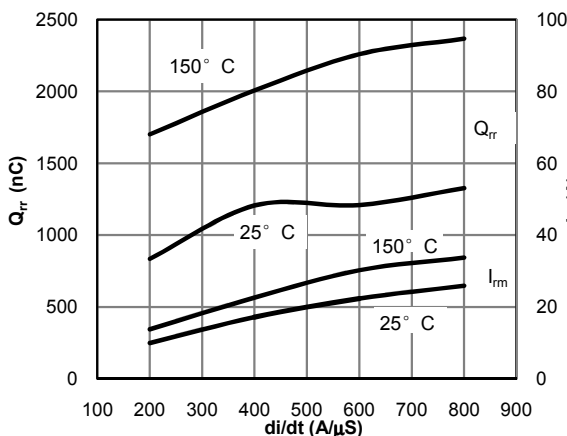
**Fig 20: Diode Forward Voltage vs. Junction Temperature**



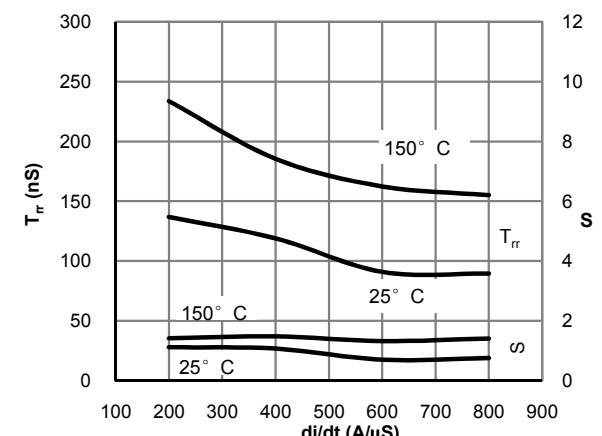
**Fig 21: Diode Reverse Recovery Charge and Peak Current vs. Conduction Current**  
( $V_{GE}=15V, V_{CE}=400V, di/dt=200A/\mu s$ )



**Fig 22: Diode Reverse Recovery Time and Softness Factor vs. Conduction Current**  
( $V_{GE}=15V, V_{CE}=400V, di/dt=200A/\mu s$ )

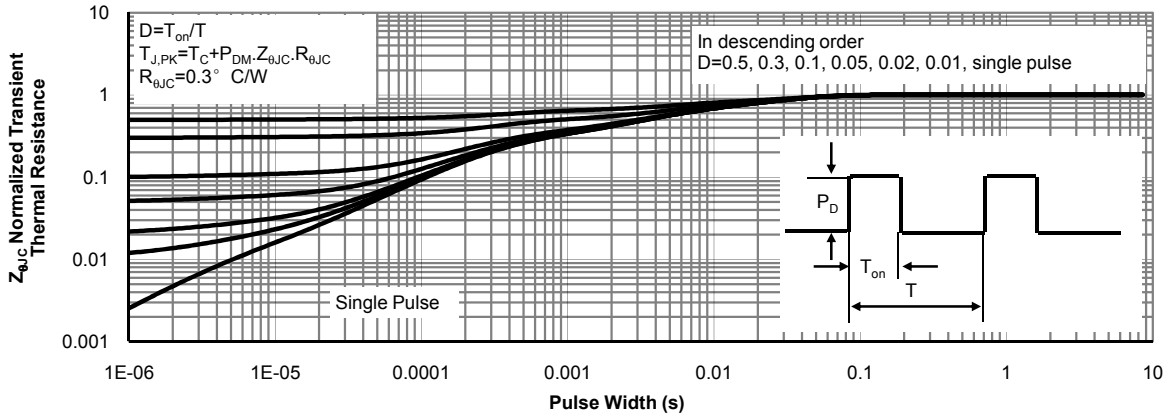


**Fig 23: Diode Reverse Recovery Charge and Peak Current vs. di/dt**  
( $V_{GE}=15V, V_{CE}=400V, I_F=30A$ )

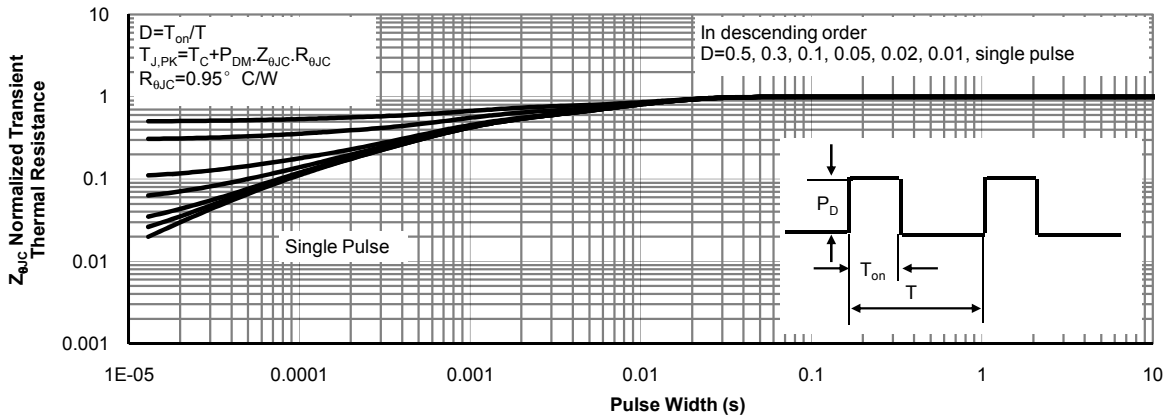


**Fig 24: Diode Reverse Recovery Time and Softness Factor vs. di/dt**  
( $V_{GE}=15V, V_{CE}=400V, I_F=30A$ )

**TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS**



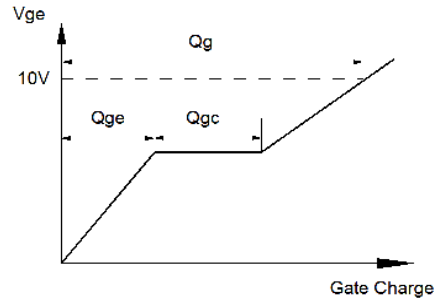
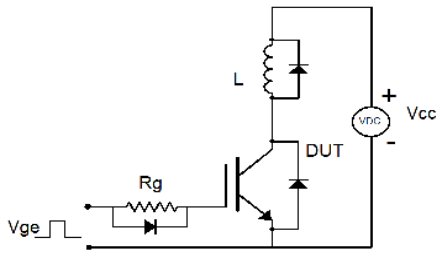
**Figure 25: Normalized Maximum Transient Thermal Impedance for IGBT**



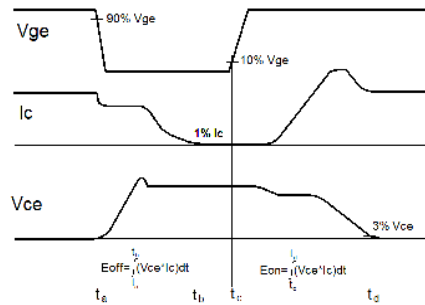
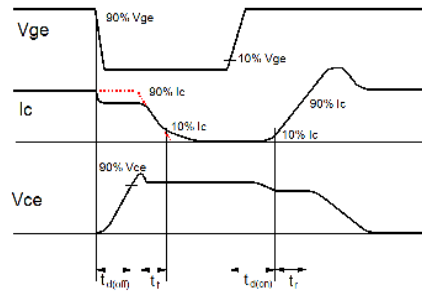
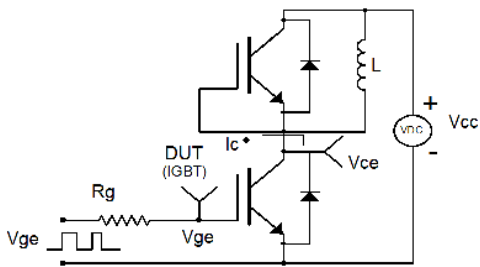
**Figure 26: Normalized Maximum Transient Thermal Impedance for Diode**



**Gate Charge Test Circuit & Waveform**



**Inductive Switching Test Circuit & Waveforms**



**Diode Recovery Test Circuit & Waveforms**

